

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Number of CD Disks::	
Number of Copies of CDs::	
Sequence Submission?::	
Computer Readable Form (CRF)?::	
Number of copies of CRF::	
Title::	DIE FOR MOLDING DISC SUBSTRATES
Attorney Docket Number::	EBINA3
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	2
Small Entity?::	Yes
Latin Name::	
Variety Denomination Name::	
Petition Included::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers::	
Secrecy Order in Parent Appl.?::	No
Applicant Information	
Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Toshiyuki
Middle Name::	

Family Name:: EBINA
Name Suffix::
City of Residence:: Aichi-ken
State or Province of Residence::
Country of Residence:: Japan
Street of Mailing Address:: Meiki Seisakusho Nai, 2, Ohne,Kitasaki-
cho, Ohbu-shi
City of Mailing Address::
State or Province of Mailing Address:: Aichi-ken
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 474-8666
Correspondence Information
Correspondence Customer Number:: 001444
Representative Information
Representative Customer Number:: 001444
Domestic Priority Information
Application:: Continuity Type:: Parent Parent Filing
Application:: Date::

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2003-137247	05-15-03	Yes

Assignment Information

Assignee Name:: Kabushiki Kaisha Meiki Seisakusho
Street of Mailing Address:: 2, Ohne, Kitasaki-cho, Ohbu-shi
City of Mailing Address:: Aichi-ken
State or Province of Mailing Address::
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 474